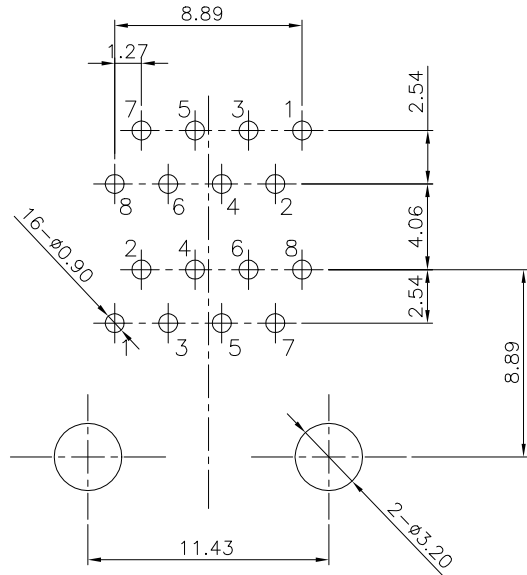
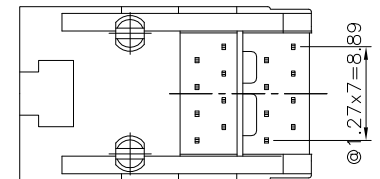
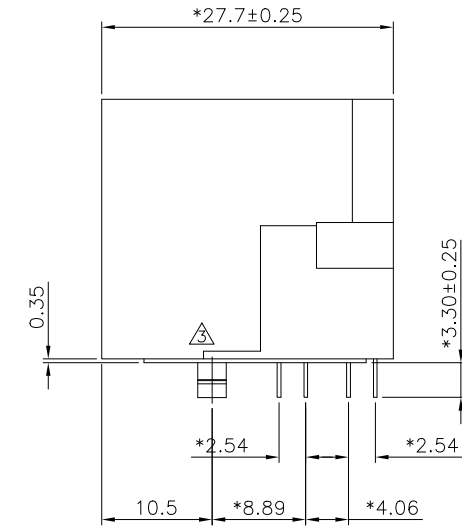
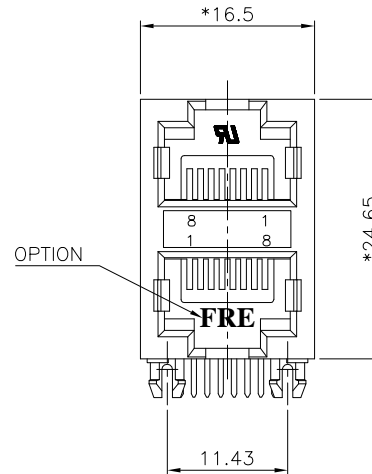


A1RFRD10

REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
△		MODIFY NOTES	Christ	10/30/03'
△		MODIFY NOTES	LUXIN	11/05/04'
△		MODIFY DRAWING	QUILER	12/03/04'
△		ADD PART NO.	Olsonpu	12/9/04'



PC Board Thickness=1.60mm  
PC Board Component Side Shown



**NOTES:**

**ELECTRICAL:**

- VOLTAGE RATING : 125 VAC RMS.
- CURRENT RATING : 1.5 AMP.
- CONTACT RESISTANCE : 50 MILLIOHMS MAX.
- INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
- DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

**MECHANICAL:**

- HOUSING MATERIAL : PBT+30%G.F. OR FR52.
- CONTACT MATERIAL: PHOSPHOR BRONZE t=0.35mm.
- PLATING : GOLD PLATING OVER NICKEL.
- OPERATING LIFE : 750 CYCLES MIN.
- PCB RETENTION PRE-SOLDER : 1 LB MIN.
- PCB RETENTION POST-SOLDER: 10 LBS MIN.

**ENVIRONMENTAL:**

- STORAGE : -40°C TO +85°C.
- OPERATION: 0°C TO 70°C.

MATES WITH MODULAR PLUG CONFORMING TO  
FCC PART 68, SUBPART F.  
UL & CUL FILE NO. E163191  
PART NUMBER: E5908-0T00XX

- 4- W/ FRE LOGO    1- 3u"    2- 6u"  
U- W/O FRE LOGO    3-15u"    4-30u"  
5-50u"



LEAD FREE P/N: E5908-0T00XX-L

- 0- PBT+30%G.F.    1- 3u"    2- 6u"  
3- FR52    3-15u"    4-30u"  
5-50u"
- 4- W/ FRE LOGO  
U- W/O FRE LOGO

DETACHED LISTS	MM (INCH)		DFTO CHI	DATE 9/16/02'	<b>FULL RISE ELECTRONIC CO., LTD</b>  TITLE RJ45 STAMPED PIN III STACKED GANG JACK (2x1)		
	TOLERANCES EXCEPT AS NOTED		CHKD LUXIN	DATE 2004/12/9			
			MFO	DATE			
			APPVLSAMMY	DATE 2004/12/9			
MM		±	MATERIAL :		DRAWING NO. GE593B81	SIZE A3	REV 4
.0 ± 0.2		±	QTY :				
.00 ± 0.15		±	FINISH :		/PART NO. SEE NOTES		DO NOT SCALE DRAWING
.000 ± 0.075		±	SCALE : 2:1				
ANGLES ± 0.5		THIRD ANGLE PROJECTION					